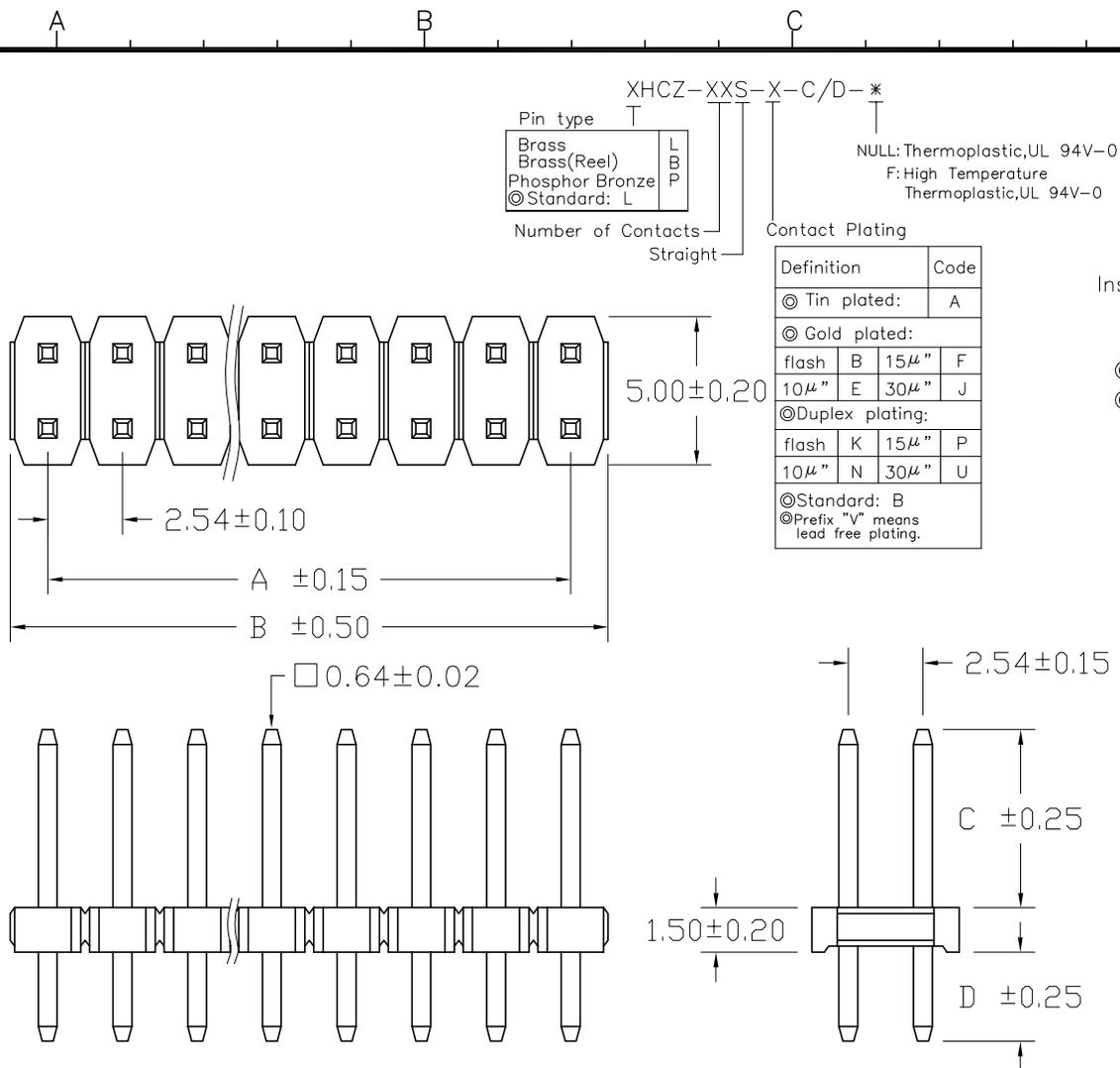


Contacts	A	B
4	2.54	5.08
6	5.08	7.62
8	7.62	10.16
10	10.16	12.70
12	12.70	15.24
14	15.24	17.78
16	17.78	20.32
18	20.32	22.86
20	22.86	25.40
22	25.40	27.94
24	27.94	30.48
26	30.48	33.02
28	33.02	35.56
30	35.56	38.10
32	38.10	40.64
34	40.64	43.18
36	43.18	45.72
38	45.72	48.26
40	48.26	50.80
42	50.80	53.34
44	53.34	55.88
46	55.88	58.42
48	58.42	60.96
50	60.96	63.50
52	63.50	66.04
54	66.04	68.58
56	68.58	71.12
58	71.12	73.66
60	73.66	76.20
62	76.20	78.74
64	78.74	81.28
66	81.28	83.82
68	83.82	86.36
70	86.36	88.90
72	88.90	91.44
74	91.44	93.98
76	93.98	96.52
78	96.52	99.06
80	99.06	101.60

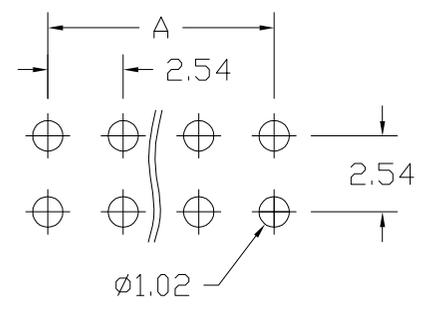


Definition	Code	
© Tin plated:	A	
© Gold plated:		
flash	B	15μ"
10μ"	E	30μ"
© Duplex plating:		
flash	K	15μ"
10μ"	N	30μ"
©Standard:	B	
©Prefix "V" means lead free plating.		

SPECIFICATIONS

Current Rating: 3 Amps
 Insulator resistance: 5000 Megohms min.
 Dielectric withstanding: AC 500 V
 Operating Temperature: -40°~+105°C
 Max Processing Temp: 230° for 30 seconds
 Contact Material: Copper Alloy
 Insulator Material: Thermoplastic, UL 94V-0 (NYLON-6T)
 Color : Black
 Finish: Tin, Gold or Duplex plated
 ©Standard: Gold flash all over
 ©Note: Duplex plating: gold plated on contact area, Tin on solder area

©For illustration purpose the XHCZ-XXS-X-060/030(-F) was shown
 Recommended PCB Layout (PCB TOLERANCE ±0.05)



Rev.	ECN Number	Description	Drawn	Date
13	EC2-530391	新增 XHCZ-XXS-X-046/030-*	陳顯鑫	03/16 05'
14	EC2-530414	新增 XHCZ-XXS-X-047/023-*	陳美竹	03/18 05'
15	EC3-530074	新增 XHCZ-XXS-X-045/033-*	陳賜農	03/30'05



GENERAL TOLERANCE		SCALE 1=1	ORIGINAL DRAWN 邱若婷	DATE 03'/10/13	DWG. NO. 3-37	TITLE 2.54X2.54.mm HEADER (成品規格圖)	REV. 15
XX. ± 0.50	XXX. ±	UNIT MM	CHECK 江坤容	DATE 03/30'05			PARTS NO. XHCZ-XXS-X-C/D-*
X. ± 0.30	.XXX ±	SIZE A4/4	APPROVE 林錫錦	DATE 03/30'05			
.X ± 0.25	X.* ± 4*						
.XX ± 0.20	.X.* ± 4*						